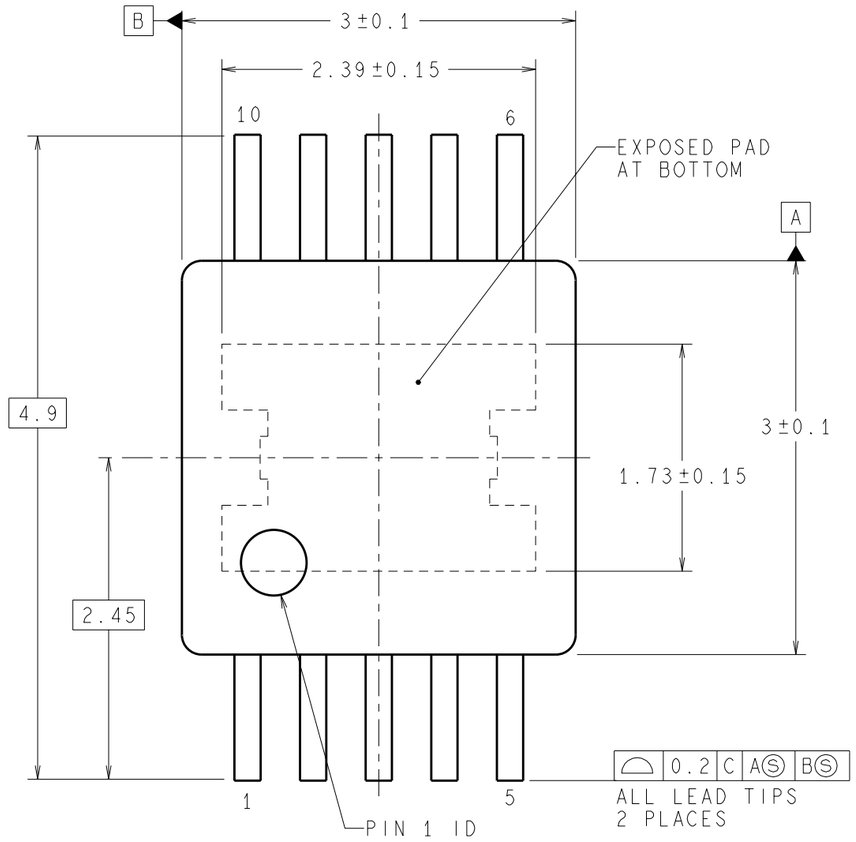
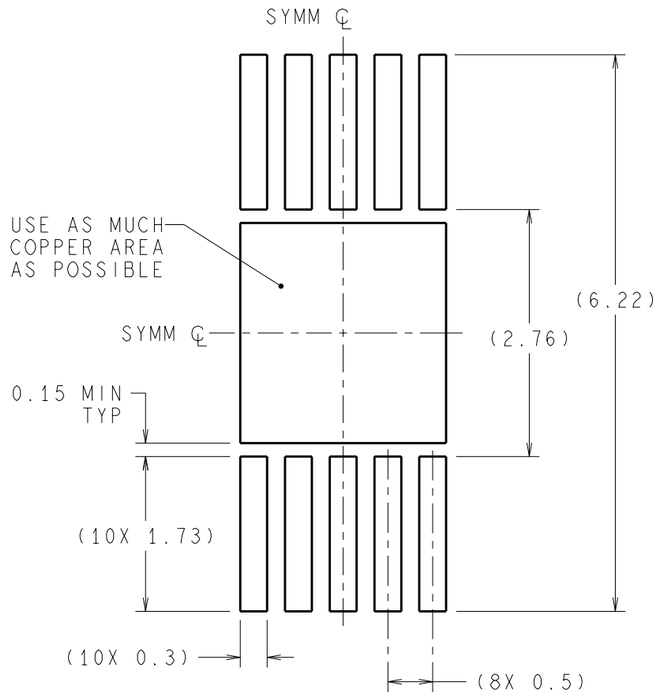
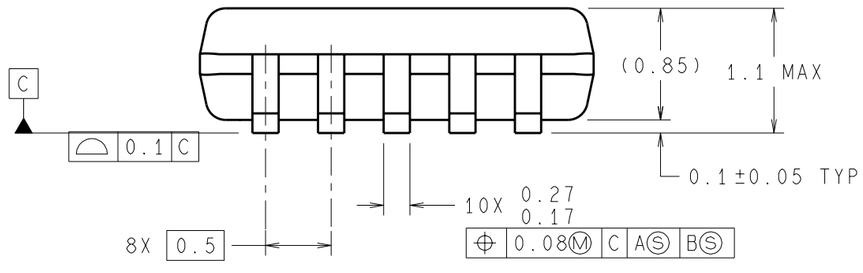
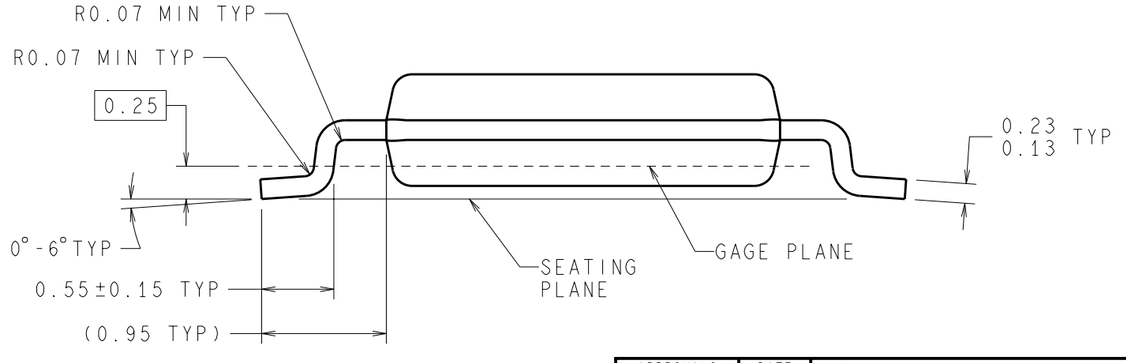
REVISIONS				
REV	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	560	02/08/2002	TL/RW





RECOMMENDED LAND PATTERN





DIMENSIONS ARE IN MILLIMETERS

NOTES: UNLESS OTHERWISE SPECIFIED

1. REFERENCE JEDEC REGISTRATION MO-187, VARIATION BA.

APPROVALS	DATE
DRAWN T LEQUANG	02/13/2002
DFTG. CHK. MARTA SUCHY	02/13/2002
ENGR. CHK. RANDALL WALBERG	02/13/2002

PROJECTION MM

National Semiconductor
2900 Semiconductor Dr, Santa Clara, CA 95052-8090

MOLDED TSSOP, EXP PAD,
3 X 3 X 0.85mm BODY,
10 LD, 0.5mm PITCH

SCALE	SIZE	DRAWING NUMBER	REV
NTS	B	(SC)MKT-MXF10A	A

FORMERLY: N/A

SHEET 1 of 1